3535 RGB LED Datasheet

Features:

- Slim Size SMD Package: Design Flexibility
- High Lumen Output and High Radiant Flux
- Stable Performance & Ceramic Base
- Excellent Color Mixing Performance
- Compact High Power Package
- Enviromental Friendly; ROHS Compliance

Applications:

- LED Stage Light, LED Hurdle Lamp, LED Landscape Lighting...
- LED Flood Light, LED Wash Washer Light, LED Underwater Light, LED Ground Light...

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PRODUCT NAMING RULES

LKL	XXXX	XX	X	X	X	Power
LKL	Type	Light Color	Chip QTY	Chip Size	Beam Angle	Brightness
LEKOLED	3535	RGB	1: 1EA	2: 28mil	0: 120°/140°	3: 3W
		RGBW	2: 2EA	3: 30mil/32mil		4: 4W
			3: 3EA	4: 42mil/45mil		
			4: 4EA			

CHARACTERISTICS

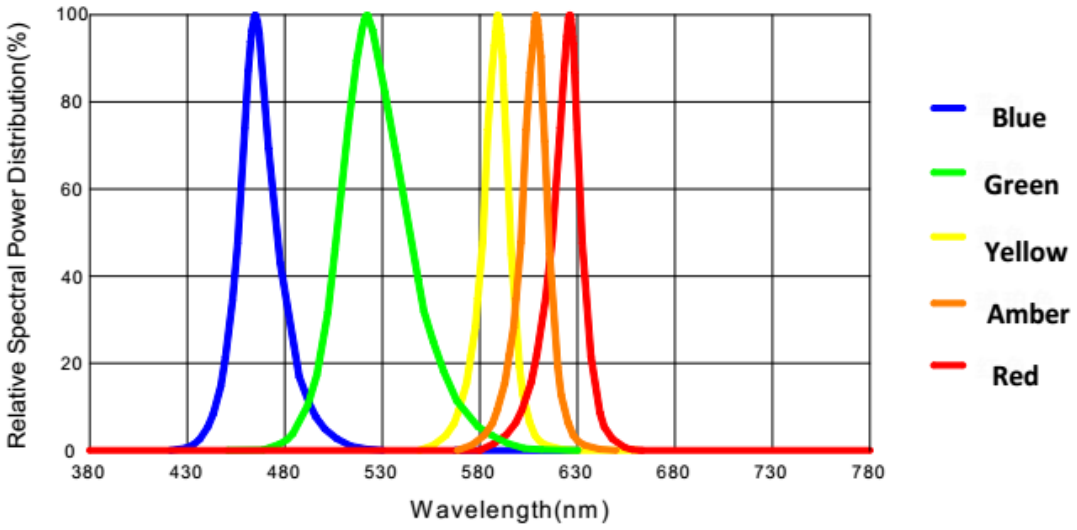
Specifications (IF=60mA, Tc=25℃)

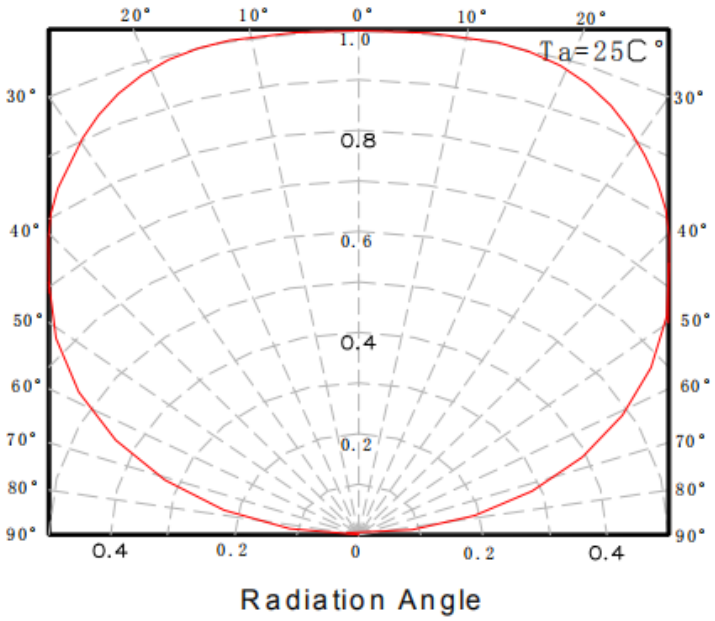
Light Color	Wavelength (nm)	Forward Voltage	Forward Current	Brightness	Model No.
RGB	R: 620-630 G: 520-530 B: 455-470	R: 2.0-2.4V G: 2.8-3.4V B: 2.8-3.4V	R: 350mA G: 350mA B: 350mA	R: 40-60LM G: 80-100LM B:20-30LM	LKL-3535RGB3303

Absolute Maximum Ratings at Tj=25°C			
Parameters	**Symbol**	**Value**	**Unit**
Forward Current	I_F	350	mA
Peak Pulsed Forward Current	I_{FP}	700	mA
Power Dissipation	P_D	1	W
Reverse Voltage	VR	5	V
Viewing Angle	2θ 1/2	120	Deg
Operating Temperature	T_{OPR}	-30 ~ +75	°C
Storage Temperature	T_{STG}	-40 ~ +85	°C
Junction Temperature	T_j	120	°C
Soldering Temperature	T_{SLD}	Reflow Soldering: 230°C or 260°C for 10Sec	

Electrical/ Optical Characteristics at Tj=25°C						
Parameters	**Symbol**	**Min**	**Type**	**Max**	**Unit**	**Condition**
Forward Voltage (Red)	v_F	1.8	---	2.4	V	IF=350mA
Forward Voltage (Green)	v_F	2.8	---	3.4	V	IF=350mA
Forward Voltage (Blue)	v_F	2.8	---	3.4	V	IF=350mA
Reverse Current	IR		10		μA	VR=5V
Thermal Resistance	Rth j-sp		8		°C/W	IF=350mA
Electrostatic Discharge	ESD		2000		V	HBM

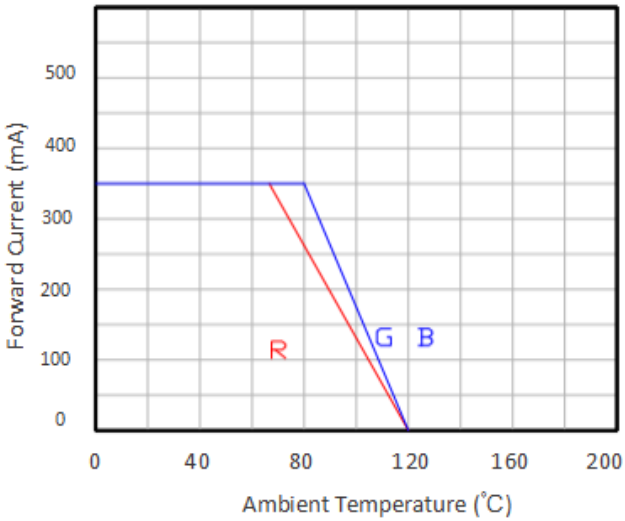
RELATIVE SPECTRAL POWER DISTRIBUTION

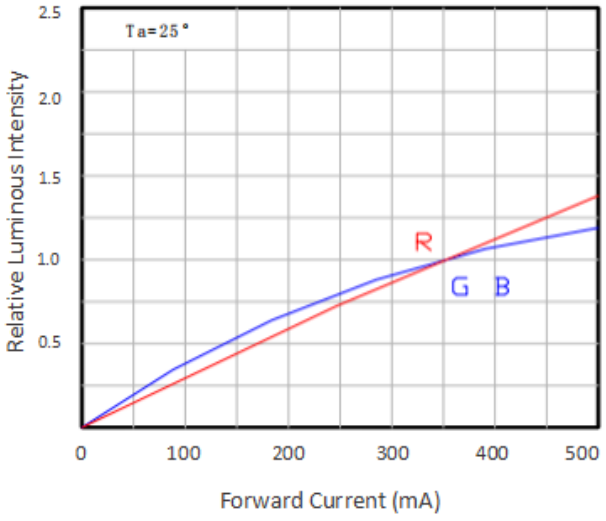


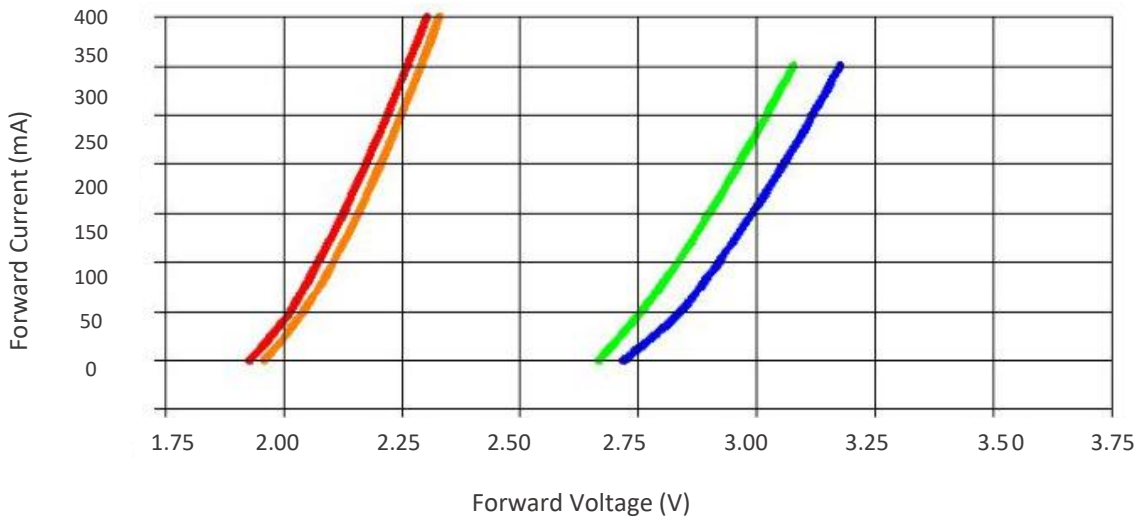


TYPICAL CHARACTERISTIC CURVES

Specifications (IF=350mA, Tc=25℃)







RELIABILITY TESTS

Test Items	Test Conditions	Sample QTY	Ac/Re
Aging Test	IF=350mA, Ta=25℃ x6000hrs	22	0/1
	IF=350mA, Ta=85℃ x6000hrs	22	0/1
High Temperature Storage	100℃ x1000hrs	22	0/1
Low Temperature Storage	-40℃ x1000hrs	22	0/1
High Temp & Humidity	IF=350mA, 85℃, 85% RH for 6000hrs	22	0/1
Temperature Shock	-40℃x30 min & +100℃x30 min, 100cycle	22	0/1
ESD(HBM)	2000V HBM/ 1 Time	10	0/1

Criteria for Judging LED Failure (Tc= 25℃)

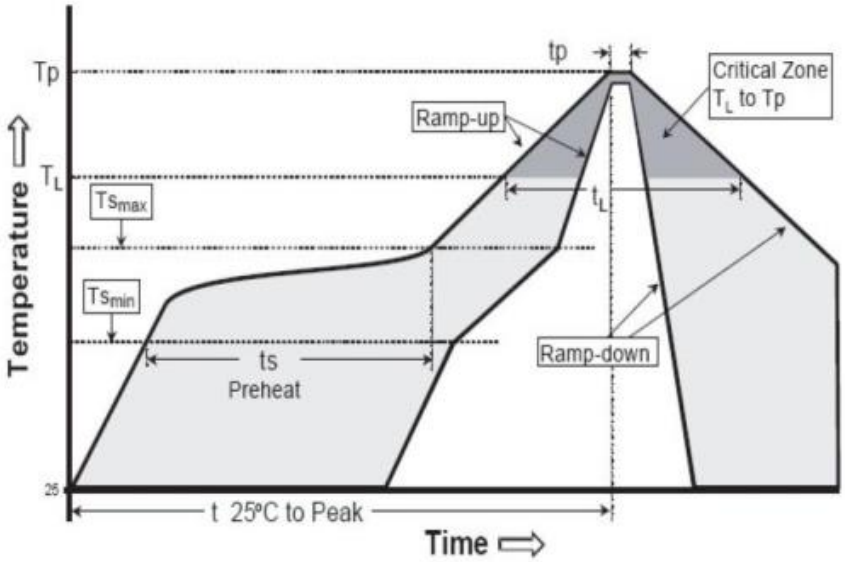
Items	Symbol	Test Conditions	Criteria for Judging LED Failure
Forward Voltage	VF	IF=350mA	>U x 1.1
Reverse Current	IR	VR=5V	IR>/= 10μA
Lumen	ΦV	IF=350mA	<S x 0.7

U refers to max value; S refers to initial value.

Notes: Judging criteria based on Tc=25℃.

TYPICAL CHARACTERISTIC CURVES

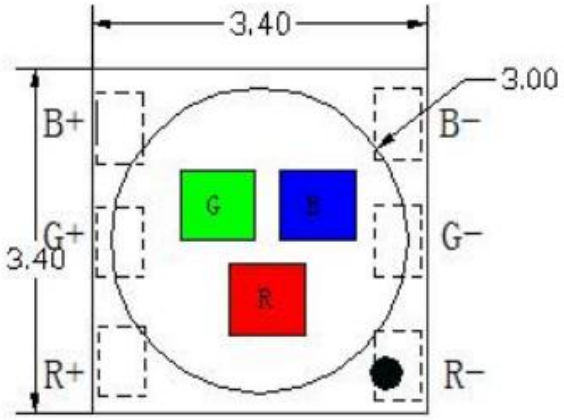
REFLOW SOLDERING PROFILE

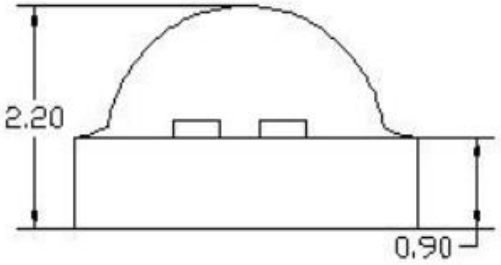


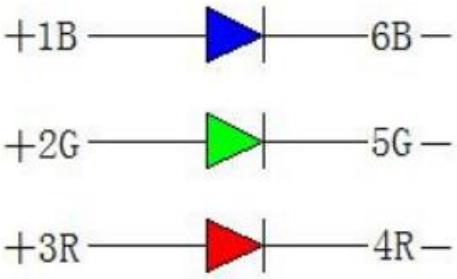
Profile Features	Lead-free solder	Lead solder	Soldering by Manual
Ramp-up Speed(Ts max to Tp)	3 °C/ second max.	3 °C/ second max.	Max. temperature: 350°C 3 seconds/1 time
Preheat: Min. Temperature(Tsmin)	150 °C	100 °C	
Preheat: Max.Temperature(Tsmax)	200 °C	150 °C	
Preheat: Time (tsmin to tsmax)	60~180 seconds	60~120 seconds	
Temperature to Keep: (TL)	217 °C	183 °C	
Time to Keep: (tL)	60~150 seconds	60~150 seconds	
Peak Temperature (Tp)	260 °C	215 °C	
Time within the peak temperature (tp)	20~40 seconds	10~30 seconds	
Ramp-down Speed	6°C/ second max.	6°C/ second max.	
Time to the peak Temperature	8 minutes max.	6 minutes max.	

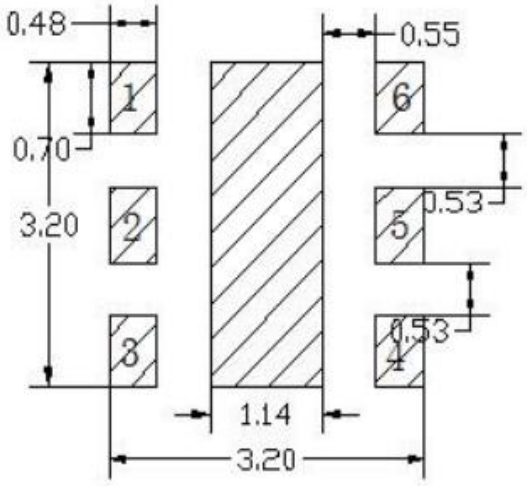
DIMENSIONS

Unit: mm









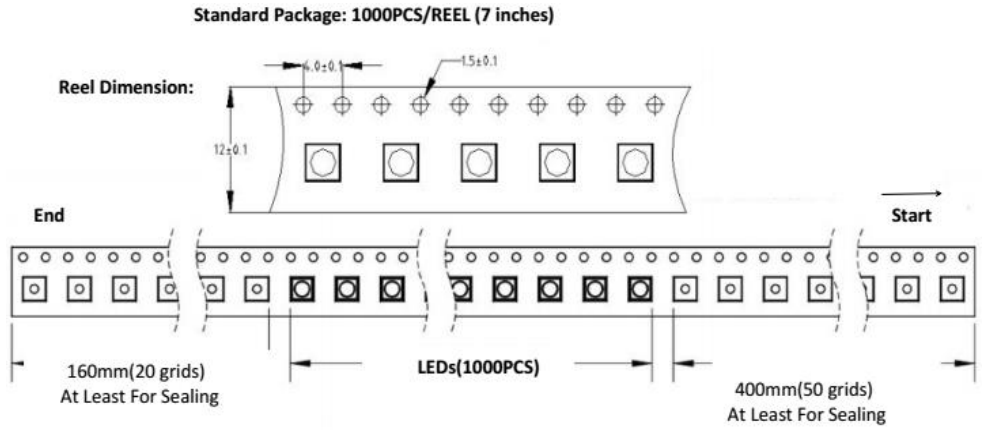
Notes：

*All dimensions are in millimeters.(tolerance:±0.2mm)

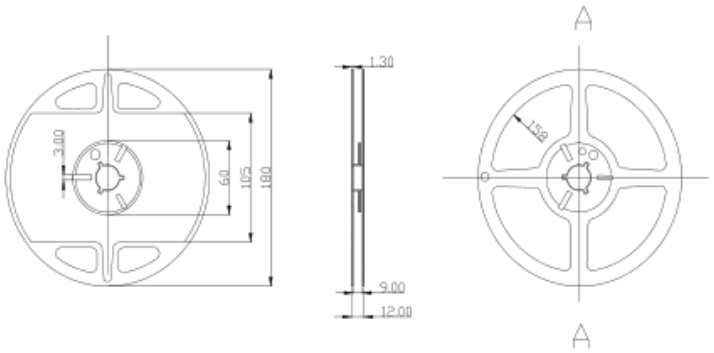
*The appearance and specifications of the product may be changed for improvement without notice.

PACKAGING

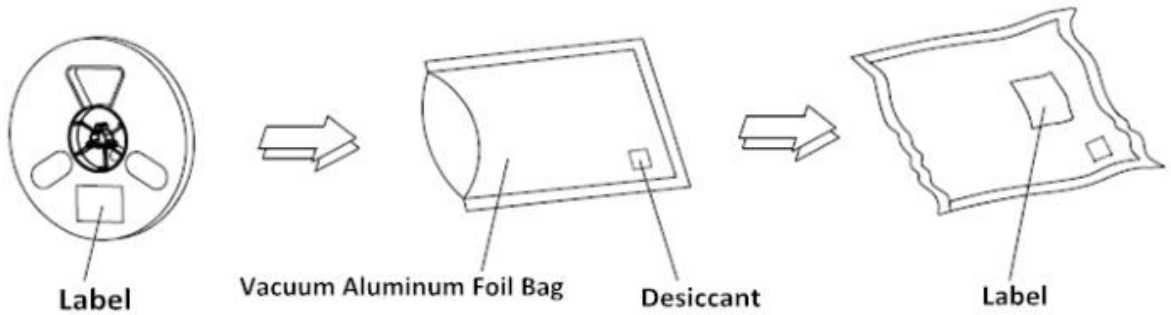
Tape Specifications (Units : mm)



Reel Dimensions



Moisture Resistant Packaging



PRECAUTIONS

1) Storage

Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to aminimum.

Before opening the package, the product should be kept at 30℃ or less and humidity less than 60% RH, and beused within a year.

After opening the package, the product should be stored at 30℃ or less and humidity less than 10%RH, and besoldered within 24 hours (1day). It is recommended that the product be operated at the workshop condition of 30℃ or less and humidity less than 60%RH.

If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (70±5)℃ for 24 hours.

2) Static Electricity

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

3) Vulcanization

LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag2S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline ,seriously affecting the performance of the product. So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

4) Safety Advice For Human Eyes

Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity will cause great hazard to human eyes. Please be careful.